5-146274-4 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 5-146274-4 PCB Mount Header, Vertical, Board-to-Board, 4 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 4

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board



Configuration Features

Connector Contact Load Condition	Fully Loaded			
PCB Mount Orientation	Vertical			
Number of Positions	4			
Number of Rows	1			
Board-to-Board Configuration	Parallel			
Electrical Characteristics				
Operating Voltage	30 VAC			
Body Features				
Connector Profile	Standard			
Primary Product Color	Black			
Contact Features				
Mating Square Post Dimension	.64 mm[.025 in]			
	100 – 200 µin			

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Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476

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Packaging Features

Packaging Quantity	500
Packaging Type	Carton

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Capability	Pin-in-Paste capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

TE Part # 146763-6 04 MODII VRT SR CE 100

Also in the Series AMPMODU Headers

C For support call+1 800 522 6752

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PCB Connector Mounting(1)	PCB Connector Shrouds(1)	PCB Headers & Receptacles(4875)	PCB Latches, Locks & Retainers(1)

Customers Also Bought

Wire-to-Board Connector Assemblies

& Housings(5)

TE Part #5499374-8	TE Part #172061-1	TE Part #170485-1	TE Part #2108614-5

Wire-to-Board Connector Contacts(65)

A/L UNIV HDR 34P VERT SHT LAT	12P DRAWER MALE HSG	DRAWER CONN LP	2.7H SPRING FINGER WITH EMBOSS
TE Part #6-1625890-4 2W SM M/OX 5% 680R	TE Part #1-1418773-1 Signal Header	TE Part #2237023-1 40P 025 CAP ASSY	TE Part #2237022-1 16P 025 CAP ASSY

Documents

Product Drawings
04 MODII HDR SRST B/A .100CL

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-146274-4_E.2d_dxf.zip

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English

Customer View Model ENG_CVM_CVM_5-146274-4_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-146274-4_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance MD_5-146274-4_020620192353_dmtec

English

MD_5-146274-4_020620192353_dmtec

English